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#21

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

David J. Corisis

Serial No.: 09/342,789

Filed: June 29, 1999

For: CHIP SCALE PACKAGE WITH
HEAT SPREADER AND METHOD OF
MANUFACTURE

Examiner: D. Graybill

Group Art Unit: 2814

Attorney Docket No.: 3384.1US
(97-564.1)

CERTIFICATE OF MAILING

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AMENDMENT

Box NON-FEE AMENDMENT
Commissioner for Patents
Washington, D.C. 20231

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OFFICE OF PETITIONS

Sir:

This application was held abandoned by the Examiner for failing to respond timely to the Office Action of March 19, 2001. This amendment is filed with a petition for revival of an application for patent abandoned unintentionally under 37 CFR 1.137(b) and is in response to the Office Action of March 19, 2001, whose initial period of response expired on June 19, 2001.